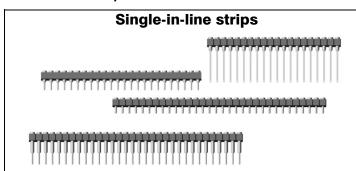
SIB/DIS/TIS - Series

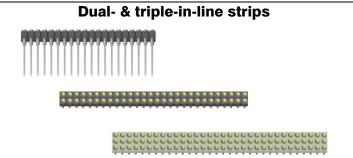
Socket Strips

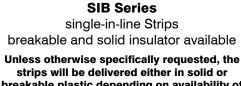
2,54mm pitch



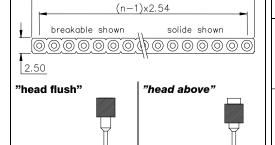




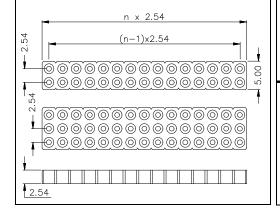




breakable plastic depending on availability of the insulator bodies. n x 2.54



DIS & TIS Series dual and triple row 2,54mm grid



SIB Series

Standard "head flush"

SIB-1xx-Fxxx-xx

Alternative: "head above"

SIB-1xx-Sxxx-xx

Number of contacts standard breakable sizes

20; 32 and 40

Number of contacts either breakable or solid available

from 02 to 40

DIS Series

DIS-2xx-Fxxx-xx

Number of contacts available

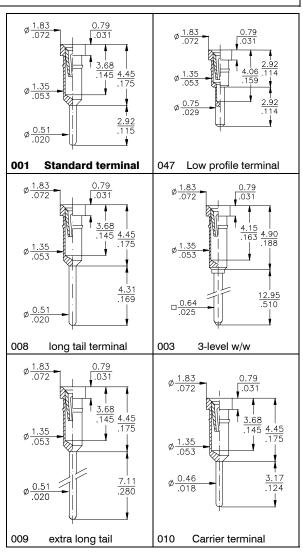
from **04** to **80**

TIS Series

TIS-3xx-Exxx-xx

Number of contacts available

from 06 to 96



Strips

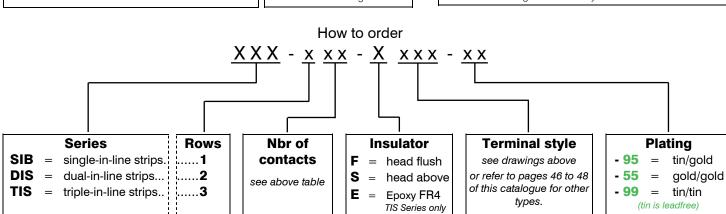
Other lengths & pin-outs available on request.

Specifications

refer to page 49 of this catalogue

Terminals

For other terminal styles please refer to the pages 46 to 48 of this catalogue or contact your closest sales office.



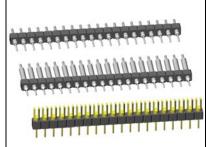
SIB/DIS/TIS - Series

Adapter Strips

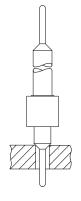
2,54mm pitch





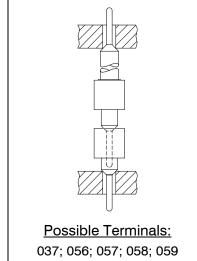


Application Examples



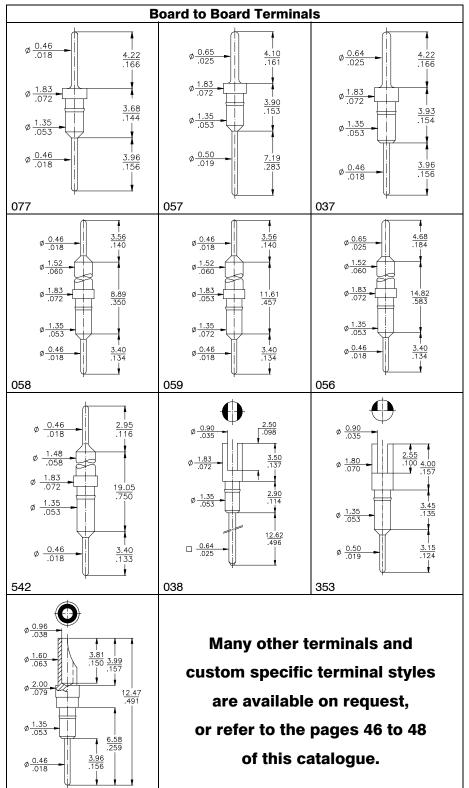
Possible Terminals:

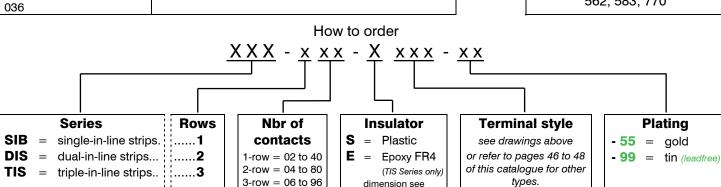
037; 056; 057; 058; 059 077; 220; 542; 544 562; 583; 770





37; 056; 057; 058; 059 077; 078; 542; 544 562; 583; 770





dimension see socket strip page 5

Super Low Profile Sockets & Adapters

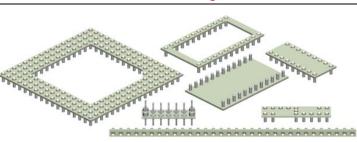




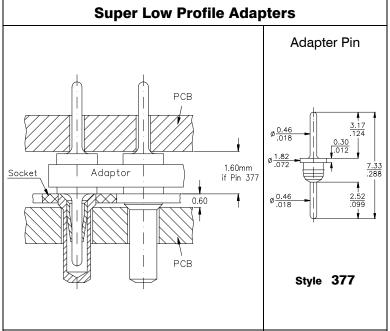
E-tec's super low profile sockets and adapters are designed for use in applications where height above board is most critical.

The sockets have a profile of 0,60mm above board and they can be combined with the adapters to achieve a board to board interconnection height of 2,20mm max.

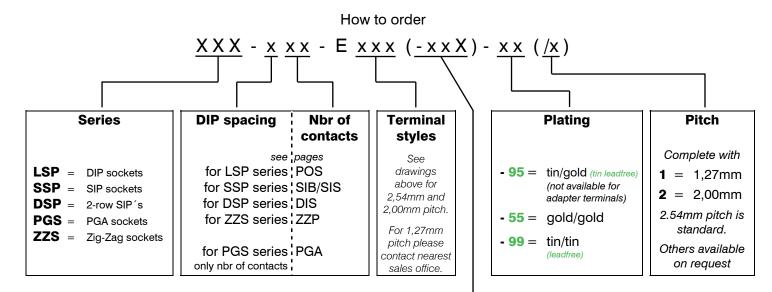
Also available in this socket range are the ultra low profile SMT sockets with a height above board of only 3,45mm.



Super Low Profile Sockets SMT use through hole use 0.60 .024 0.50 **PCB PCB** DIM "C" **Terminal style** DIM "A" DIM "B" DIM "D" DIM "F" 144 3,45/.136 3,05/.120 0,94/.037 0,45/.018 1,15/.045



Specifications Mechanical data **Electrical data** Force per contact (avg) 0,70N insertion / 0.25N extraction Breakdown voltage at 60 Hz 500 V AC Contact life >50 cycles min. Contact resistance at 1A $4,3 \text{ m}\Omega \text{ typ}$ Solderability as per IEC 60068-2-58 Insulation resistance $5 \times 10^9 \Omega$ min. Current rating 1A max., 100V **Material** Capacitance 2 pF max. Terminal (RoHS compliant) BeCu **Operating temperature** Insulator -55 °C to +125 °C Glass Epoxy FR4 (RoHS compliant)



Grid size & Configuration code only for PGA sockets

Please refer to PGA socket pages 29 to 31